## SanRex<sub>®</sub>

# TRIAC For High Power

## **TG40E80**

 $I_{T(RMS)} = 40A$ ,  $V_{DRM} = 800V$ 

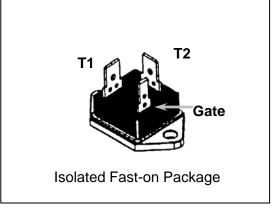
**SanRex** Triac **TG40E80** is specially designed use for high power AC switching application. Thanks to SanRex's new isolated diffusion technology, the Triac **TG40E80** features high dv/dt, dv/dt/c and very low on-state voltage. These benefits make this design an extremely reliable and efficient device for use in wide variety of applications.

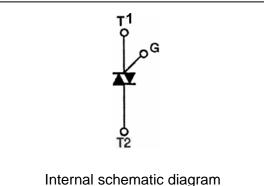
#### **Features**

- \* High Power
- \* High Surge Current
- \* Low On-State Voltage
- \* High Commutation Performance
- \* UL registered E76102

### **Typical Applications**

- \* Home Appliances
- \* Water Heaters
- \* Heater Controls
- \* Lighting Controls
- \* Temperature Controls





Maximum Ratings> (Ti = 25°C unless otherwise noted)

iviaxiiiiuii	i Raungs>	(1) = 25 C  unless otherwise noted		
Symbol	Item	Conditions	Ratings	Unit
$V_{DRM}$	Repetitive Peak Off-state Voltage		800	V
I <sub>T(RMS)</sub>	R.M.S. On-state Current	T <sub>C</sub> = 64°C	40	А
I <sub>TSM</sub>	Surge On-state Current	One cycle, 60Hz, Peak, non-repetitive	420	А
l²t	I <sup>2</sup> t (for fusing)	Value for one cycle surge current	730	A <sup>2</sup> s
P <sub>GM</sub>	Peak Gate Power Dissipation		10	W
P <sub>G(AV)</sub>	Average Gate Power Dissipation		1	W
I <sub>GM</sub>	Peak Gate Current		3	А
V <sub>G M</sub>	Peak Gate Voltage		10	V
di/dt	Critical Rate of Rise of On-State Current	$I_G$ =100mA, $V_D$ =1/2 $V_{DRM}$ , $di_G/dt$ =1A/ $\mu$ s	50	A/Fs
Tj	Operation Junction Temperature		-40 to +125	°C
Tstg	Storage Temperature		-40 to +150	°C
V <sub>ISO</sub>	Isolation Breakdown Voltage	R.M.S., A.C. 1 minute	2500	V
	Mounting Torque (M4)	Recommended value 1.0 – 1.4 N*m	1.5	N*m
	Mass	Typical Value	23	g

## **SanRex**®

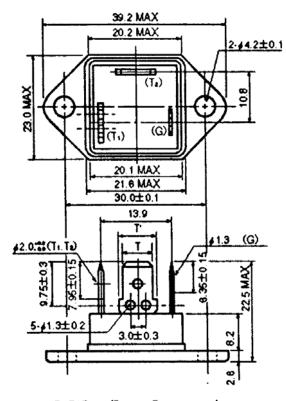
## TRIAC for High Power

**TG40E80** 

< Electrical Characteristics >

/T:	25 C unle	41	· · · · -   -   · -	41\

Symbol	Item	Conditions	Ratings		l lmit		
			Min.	Тур.	Max.	Unit	
I <sub>DRM</sub>	Repe	titive Peak Off-state Current	$T_{j} = 125^{\circ}C, V_{D} = V_{DRM}$			5	mΑ
$V_{TM}$	Peak On-State Voltage		I <sub>T</sub> =60A, Instant measurement			1.4	V
I <sub>GT</sub> 1 <sup>+</sup>	QI	- Gate Trigger Current	$V_D = 6V$ , $I_T = 1A$			50	mA
I <sub>GT</sub> 1 <sup>-</sup>	QII					50	mA
I <sub>GT</sub> 3⁺	QIV					-	mA
I <sub>GT</sub> 3⁻	QIII					50	mA
$V_{GT}1^{+}$	QI		V <sub>D</sub> = 6V, I <sub>T</sub> =1A			1.5	V
$V_{GT}1^{-}$	QII	Gate Trigger Voltage				1.5	V
$V_{GT}3^{+}$	QIV					-	V
$V_{GT}3^{-}$	QIII					1.5	V
$V_{GD}$	Non-Trigger Gate Voltage		$Tj = 125^{\circ}C, V_D=1/2V_{DRM}$	0.2			V
dv/dt	Critical Rate of Rise of Off-State Voltage		$Tj = 125$ °C, $V_D=1/2V_{DRM}$ , Exponential wave	500			V/F s
(dv/dt)c	Critical Rate of Rise of Commutation Voltage		$Tj = 125^{\circ}C$ , $V_D = 2/3V_{DRM}$ , $(di/dt)c = 10 A/ms$	6			V/Fs
Ι <sub>Η</sub>	Holding Current				30		mA
Rth(j-c)	Thermal Resistance		Junction to case			1.3	°C/W



T<sub>1</sub>: TAB250 (T=6.35, T=8.25, t=0.8) T<sub>2</sub>: TAB250 (T=6.35, T=8.25, t=0.8) G: TAB187 (T=4.75, T'=5.7, t=0.8)

<sup>\*</sup> Dimensions in millimeters